	Application No.	Applicant(s)
Notice of Allowability	10/200 505	
	10/606,525 Examiner	PETERSON, KENNETH A. Art Unit
	Shouxiang Hu	2811
The MAILING DATE of this communication appear All claims being allowable, PROSECUTION ON THE MERITS IS herewith (or previously mailed), a Notice of Allowance (PTOL-85) NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT R of the Office or upon petition by the applicant. See 37 CFR 1.313	(OR REMAINS) CLOSED in this ap or other appropriate communication IGHTS. This application is subject to	plication. If not included n will be mailed in due course. THIS
1. This communication is responsive to 12/22/04.		
2. \boxtimes The allowed claim(s) is/are <u>6-9,12-20,22 and 48</u> .		
3. The drawings filed on <u>26 June 2003</u> are accepted by the Examiner.		
 4. ☐ Acknowledgment is made of a claim for foreign priority unalled All b) ☐ Some* c) ☐ None of the: 1. ☐ Certified copies of the priority documents have 2. ☐ Certified copies of the priority documents have 3. ☐ Copies of the certified copies of the priority documents have International Bureau (PCT Rule 17.2(a)). * Certified copies not received: 	e been received. e been received in Application No	
Applicant has THREE MONTHS FROM THE "MAILING DATE" noted below. Failure to timely comply will result in ABANDONN THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.		complying with the requirements
5. A SUBSTITUTE OATH OR DECLARATION must be subminformal PATENT APPLICATION (PTO-152) which give		
6. CORRECTED DRAWINGS (as "replacement sheets") must (a) including changes required by the Notice of Draftspers 1) hereto or 2) to Paper No./Mail Date	son's Patent Drawing Review (PTO s Amendment / Comment or in the C	Office action of
Identifying indicia such as the application number (see 37 CFR 1 each sheet. Replacement sheet(s) should be labeled as such in t		
7. DEPOSIT OF and/or INFORMATION about the depo attached Examiner's comment regarding REQUIREMENT		
Attachment(s) 1. Notice of References Cited (PTO-892)	<u></u>	Patent Application (PTO-152)
2. Notice of Draftperson's Patent Drawing Review (PTO-948)	6. ⊠ Interview Summary Paper No./Mail Da	
3. Information Disclosure Statements (PTO-1449 or PTO/SB/0 Paper No./Mail Date		
4. Examiner's Comment Regarding Requirement for Deposit	8. Examiner's Stateme	ent of Reasons for Allowance
of Biological Material	9. 🗌 Other Shousing	ug flu
	SHOUXI/ PRIMARY E	ANG HU

EXAMINER'S AMENDMENT

An examiner's amendment to the record appears below. Should the changes and/or additions be unacceptable to applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

Authorization for this examiner's amendment was given in a telephone interview with Robert D. Walton (RN: 45,604) on April 11, 2005.

The application has been amended as follows:

IN THE CLAIMS

1-5. (CANCELLED)

- 6. (CURRENTLY AMENDED) A microelectronic device, comprising:
- an electrically insulating substrate;
- a first electrical conductor disposed on the substrate;
- a microelectronic device attached to the substrate, wherein the device comprises an active area and a passive area;
- a second electrical conductor disposed on the device, located within the passive area:
- an electrical interconnection formed between the first and second electrical conductors; and
- an electrically insulating, protective coating covering the first and second electrical conductors, the electrical interconnection, and the passive area, but not covering the

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active area a portion of the protective coating being removed so as to expose the active area before MEMS elements in the active area being released.

wherein the thickness of the protective coating is less than or equal to 100 microns.

- 7. (Original) The microelectronic device of claim 6, wherein the substrate comprises one or more electrically insulating materials selected from the group consisting of ceramic, plastic, printed wiring board material, polymer, multi-layered material, LTCC ceramic multilayered material, and HTCC ceramic multilayered material.
- 8. (PREVIOUSLY PRESENTED) The microelectronic device of claim 6, wherein the substrate comprises a package having a geometry selected from the group consisting of DIP, ceramic dual inline packaging (or, CERDIP), quad flatpack, pin grid array, leadless chip carrier, and a leaded flatpack.
- 9. (CURRENTLY AMENDED) The microelectronic device of claim 6, comprising one or more active elements, disposed within the active area, selected from the group consisting of MEMS-elements, optically sensitive elements, temperature sensitive elements, heat sensitive elements, chemical sensitive elements, pressure sensitive elements, and microsensors.
 - 10. (CANCELLED)
 - 11. (CANCELLED)
- 12. (Original) The microelectronic device of claim 6, wherein the electrical interconnection comprises a wirebond or a flip-chip ball or bump.
- 13. (PREVIOUSLY PRESENTED) The microelectronic device of claim 6, wherein the device is flip-chip mounted to the substrate, and wherein the substrate comprises an

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aperture aligned over the active area, whereby the active area is accessible through the aperture.

- 14. (CURRENTLY AMENDED) The microelectronic device of claim [[6]] 13, wherein the package comprises a transparent window disposed across the aperture.
- 15. (Original) The microelectronic device of claim 6, wherein the electrically insulating protective coating comprises one or more materials selected from the group consisting of a vapor-deposited coating, a vacuum vapor deposited coating, a chemical vapor deposited coating, a water-insoluble coating, a water-soluble coating, a dry-etchable coating, a conformal coating, a pin-hole free coating, parylene, a photopatternable/photoimagable material, photoresist, a low viscosity photoresist, an epoxy based negative resist, SU-8, SU-8 2000, a sputtered coating, an evaporated coating, a ceramic coating, silicon nitride, aluminum oxide, mullite, a sprayed coating, a self-assembled monolayered material, cyanoacrylate, perfluoropolyether, hexamethyidisilazane, perfluorodecanoic carboxylic acid, silicon dioxide, TEOS, silicate glass, a fast-etch glass, silicon, and polysilicon.
- 16. (Original) The microelectronic device of claim 6, wherein the electrically insulating protective coating comprises one or more materials selected from the group consisting of poly-para-xylylene, poly-para-xylylene that has been modified by the substitution of a chlorine atom for one of the aromatic hydrogens, and poly-para-xylylene that has been modified by the substitution of the chlorine atom for two of the aromatic hydrogens.
- 17. (PREVIOUSLY PRESENTED) The microelectronic device of claim 6, wherein the passive area comprises an integrated circuit.
- 18. (PREVIOUSLY PRESENTED) The microelectronic device of claim 6, further comprising an electrically conductive overcoat deposited on top of the electrically

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insulating protective coating, whereby the electrically conductive overcoat provides electromagnetic shielding.

19. (PREVIOUSLY PRESENTED) The microelectronic device of claim 18, wherein the electrically conductive overcoat comprises one or more conductive materials selected from the group consisting of a metal, gold, tungsten, nickel, aluminum, copper, titanium, molybdenum, tin, tantalum, a metal alloy, an electrically-conductive polymer, carbon, doped carbon, and doped silicon.

20. (PREVIOUSLY PRESENTED) The microelectronic device of claim 6, wherein the conductive overcoat is continuous across two or more adjacent electrical interconnections.

21. (CANCELLED)

22. (PREVIOUSLY PRESENTED) The microelectronic device of claim 6, wherein the substrate comprises an interposer or an interposer with an aperture aligned with the active area.

23-47. (CANCELLED)

48. (PREVIOUSLY PRESENTED) The microelectronic device of claim 6, wherein the thickness of the protective coating is less than or equal to 100 angstroms.

Allowable Subject Matter

Claims 6-9, 12-20, 22 and 48 are allowed.

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Conclusion

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Any inquiry concerning this communication or earlier communications from the examiner should be directed to Shouxiang Hu whose telephone number is 571-272-1654. The examiner can normally be reached on Monday through Thursday, 7:30 AM to 6:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie C. Lee can be reached on 571-272-1732. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

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April 11, 2005 Shousmaca

SHOUXIANG HU PRIMARY EXAMINED